DATA SHEET

NEC

BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu PC29xxB$ Series

THREE-TERMINAL LOW DROPOUT VOLTAGE REGULATOR (OUTPUT CURRENT: 1.0 A)

DESCRIPTION

The μ PC29xxB series is a series of three-terminal low dropout voltage regulators with 1.0 A output current. This series is suitable for low voltage operated IC and has 4 output voltage types, 1.8 V, 2.5 V, 3.3 V and 5.0 V. Compared with the μ PC29xx and μ PC29xxA series, this series has improved output voltage tolerance (Vo ± 2%), quiescent current (1.8 mA TYP. (Io = 0 A)), and short-circuit current.

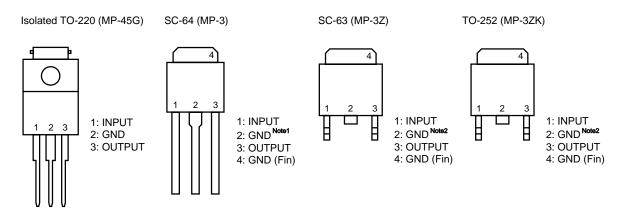
FEATURES

- Output current capacity: 1.0 A
- Output voltage tolerance: Vo \pm 2% (TA = 25°C)
- Low quiescent current: 1.8 mA TYP. (Io = 0 A)
- Low short-circuit current: 0.3 A TYP. (μPC2918B), 0.6 A TYP. (μPC2925B, μPC2933B), 0.65 A TYP. (μPC2905B)
- Low dropout voltage: VDIF = 0.6 V MAX. (Io = 0.5 A)
- On-chip inrush current protection circuit at the time of input voltage rising (when input voltage is low)
- On-chip over-current limiter
- On-chip thermal shut down circuit

APPLICATIONS

Digital TV, DVD, LCD Monitors, Printers, Audio, Air Conditioners, and other applications.

PIN CONFIGURATIONS (Marking Side)



Notes 1. No.2 pin and No.4 fin are common GND.

2. No.2 pin is cut. No.2 pin and No.4 fin are common GND.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.

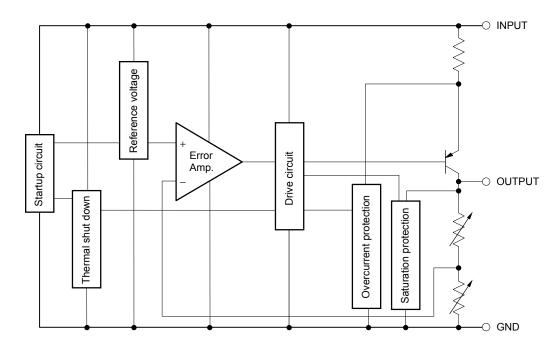
Document No. G17567EJ4V0DS00 (4th edition) Date Published August 2007 NS Printed in Japan

The mark <R> shows major revised points.

© NEC Electronics Corporation 2005, 2007

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

BLOCK DIAGRAM



<R> ORDERING INFORMATION

Part Number	Package	Output Voltage	Marking
μPC2918BHF	Isolated TO-220 (MP-45G)	1.8 V	2918B
μPC2918BHB	SC-64 (MP-3)	1.8 V	2918B
μPC2918BT	SC-63 (MP-3Z)	1.8 V	2918B
μPC2918BT1D	TO-252 (MP-3ZK)	1.8 V	2918BD
μPC2925BHF	Isolated TO-220 (MP-45G)	2.5 V	2925B
μPC2925BHB	SC-64 (MP-3)	2.5 V	2925B
μPC2925BT	SC-63 (MP-3Z)	2.5 V	2925B
μPC2925BT1D	TO-252 (MP-3ZK)	2.5 V	2925BD
μPC2933BHF	Isolated TO-220 (MP-45G)	3.3 V	2933B
μPC2933BHB	SC-64 (MP-3)	3.3 V	2933B
μPC2933BT	SC-63 (MP-3Z)	3.3 V	2933B
μPC2933BT1D	TO-252 (MP-3ZK)	3.3 V	2933BD
μPC2905BHF	Isolated TO-220 (MP-45G)	5.0 V	2905B
μPC2905BHB	SC-64 (MP-3)	5.0 V	2905B
μPC2905BT	SC-63 (MP-3Z)	5.0 V	2905B
μPC2905BT1D	TO-252 (MP-3ZK)	5.0 V	2905BD

Remark Tape-packaged products have the symbol -E1, or -E2 suffixed to the part number. In Pb-free products, any of -AT, -AZ or -AY is added to the end of their part number. Refer to the following table for details.

Part Number Note1	Package	Package Type
μPC29xxBHF	Isolated TO-220 (MP-45G)	Packed in envelop
µPC29xxBHF-AZ	Isolated TO-220 (MP-45G)	Packed in envelop
μPC29xxBHB	SC-64 (MP-3)	Packed in envelop
μPC29xxBHB-AZ ^{Note2}	SC-64 (MP-3)	Packed in envelop
μPC29xxBHB-AY ^{Note3}	SC-64 (MP-3)	Packed in envelop
μPC29xxBT	SC-63 (MP-3Z)	Packed in envelop
μPC29xxBT-AZ Note2	SC-63 (MP-3Z)	Packed in envelop
μPC29xxBT-E1	SC-63 (MP-3Z)	 16 mm wide embossed taping
		Pin 1 on draw-out side
		2000 pcs/reel
μPC29xxBT-E1-AZ ^{Note2}	SC-63 (MP-3Z)	 16 mm wide embossed taping
		Pin 1 on draw-out side
		• 2000 pcs/reel
μPC29xxBT-E1-AY ^{Note3}	SC-63 (MP-3Z)	 16 mm wide embossed taping
		Pin 1 on draw-out side
		• 2000 pcs/reel
μPC29xxBT-E2	SC-63 (MP-3Z)	 16 mm wide embossed taping
		Pin 1 at take-up side
		• 2000 pcs/reel
µPC29xxBT-E2-AZ ^{Note2}	SC-63 (MP-3Z)	 16 mm wide embossed taping
		 Pin 1 at take-up side
		• 2000 pcs/reel
μPC29xxBT-E2-AΥ ^{Note3}	SC-63 (MP-3Z)	 16 mm wide embossed taping
		 Pin 1 at take-up side
		• 2000 pcs/reel
μPC29xxBT1D-E1	TO-252 (MP-3ZK)	 16 mm wide embossed taping
		Pin 1 on draw-out side
		• 2500 pcs/reel
μPC29xxBT1D-E1-AT ^{Note4}	TO-252 (MP-3ZK)	 16 mm wide embossed taping
		Pin 1 on draw-out side
		• 2500 pcs/reel
μ PC29xxBT1D-E2	TO-252 (MP-3ZK)	16 mm wide embossed taping
		Pin 1 at take-up side
Notod		2500 pcs/reel
μPC29xxBT1D-E2-AT ^{Note4}	TO-252 (MP-3ZK)	 16 mm wide embossed taping
		Pin 1 at take-up side
		2500 pcs/reel

Notes 1. xx stands for symbols that indicate the output voltage.

2. Pb-free (This product does not contain Pb in the external electrode.)

3. Pb-free (This product does not contain Pb in the external electrode, Sn100% plating.)

4. Pb-free (This product does not contain Pb in the external electrode and other parts.)

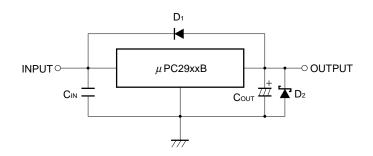
Parameter Symbol		Rat	Unit	
		μPC29xxBHF	μPC29xxBHB, μPC29xxBT, μPC29xxBT1D	
Input Voltage VIN		-0.3 to +16.0		V
Internal Power Dissipation (Tc = 25° C) ^{Note}	P⊤	15	10	W
Operating Ambient Temperature	TA	–40 t	°C	
Operating Junction Temperature	ТJ	–40 tc	°C	
Storage Temperature	Tstg	-55 to +150		°C
Thermal Resistance (junction to case)	Rth(J-C)	7	12.5	°C/W
Thermal Resistance (junction to ambient) Rth(65	125	°C/W

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Note Internally limited. When the operating junction temperature rises above 150°C, the internal circuit shuts down the output voltage.

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

TYPICAL CONNECTION



- C_{IN} : 0.1 μ F or higher. Be sure to connect C_{IN} to prevent parasitic oscillation. Set this value according to the length of the line between the regulator and the INPUT pin. Use of a film capacitor or other capacitor with first-rate voltage and temperature characteristics is recommended. If using a laminated ceramic capacitor, it is necessary to ensure that C_{IN} is 0.1 μ F or higher for the voltage and temperature range to be used.
- Cout: 10 μF or higher. Be sure to connect Cout to prevent oscillation and improve excessive load regulation. Place CIN and Cout as close as possible to the IC pins (within 1 to 2 cm). Also, use an electrolytic capacitor with low impedance characteristics if considering use at sub-zero temperatures.
- D_1 : If the OUTPUT pin has a higher voltage than the INPUT pin, connect a diode.
- D₂ : If the OUTPUT pin has a lower voltage than the GND pin, connect a Schottky barrier diode.

Caution Make sure that no voltage is applied to the OUTPUT pin from external.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Type Number	MIN.	TYP.	MAX.	Unit
Input Voltage	VIN	μPC2918B	2.8		12.0	V
		μPC2925B	3.5		12.0	V
		μPC2933B	4.3		12.0	V
		μPC2905B	6.0		12.0	V
Output Current	lo	All	0		1.0	А
Operating Ambient Temperature	TA	All	-40		+85	°C
Operating Junction Temperature	TJ	All	-40		+ 125	°C

Caution Use of conditions exceeding the above-listed recommended operating conditions is not a problem as long as the absolute maximum ratings are not exceeded. However, since the use of such conditions diminishes the margin of safety, careful evaluation is required before such conditions are used.

ELECTRICAL CHARACTERISTICS

μ PC2918B (T_J = 25°C, V_{IN} = 2.8 V, Io = 0.5 A, C_{IN} = 0.1 μ F, Cout = 10 μ F, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V ₀₁		1.764	1.8	1.836	V
	V ₀₂	$2.8 \text{ V} \leq V_{\text{IN}} \leq 12 \text{ V}, \text{ 0 A} \leq I_{\text{O}} \leq 1 \text{ A}$	(1.746)	_	(1.854)	V
Line Regulation	REGIN	$2.8~V \leq V_{IN} \leq 12~V$	_	4.0	25.0	mV
Load Regulation	REG∟	$0 A \le I_0 \le 1 A$	-	3.5	30.0	mV
Quiescent Current	BIAS	Io = 0 A	_	1.8	4.0	mA
		lo = 0.5 A	-	18.0	(30.0)	mA
Startup Quiescent Current	BIAS(S)	V _{IN} = 1.7 V, Io = 0 A	_	1.0	30.0	mA
		V _{IN} = 2.4 V, Io = 1 A	_	_	(80.0)	mA
Quiescent Current Change	⊿Ibias	$2.8~V \leq V_{IN} \leq 12~V$	-	(3.0)	(15.0)	mA
Output Noise Voltage	Vn	10 Hz ≤ f ≤ 100 kHz	_	50.0	_	$\mu V_{r.m.s.}$
Ripple Rejection	R•R	f = 120 Hz, 2.8 V \leq V $_{\rm IN}$ \leq 3.8 V, Io = 0.3 A	_	62	_	dB
Dropout Voltage	VDIF	lo = 0.5 A	_	0.3	0.6	V
		Io = 1 A	_	(0.7)	_	V
Short Circuit Current	lOshort	V _{IN} = 2.8 V	(0.1)	0.3	(0.8)	А
		V _{IN} = 12 V	-	(0.4)	-	А
Peak Output Current	Opeak	V _{IN} = 2.8 V	1.0	1.3	(1.6)	Α
		V _{IN} = 12 V	-	(1.1)	-	А
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	$0^{\circ}C \leq T_{J} \leq 125^{\circ}C, \ Io = 5 \ mA$	_	0.1	_	mV/°C

Remark Values in parentheses are product design values, and are thus provided as reference values.

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V ₀₁		2.45	2.5	2.55	V
	V ₀₂	$3.5 \text{ V} \leq V_{\text{IN}} \leq 12 \text{ V}, 0 \text{ A} \leq \text{Io} \leq 1 \text{ A}$	(2.425)	_	(2.575)	V
Line Regulation	REGIN	$3.5~V \leq V_{\text{IN}} \leq 12~V$	_	5.5	25.0	mV
Load Regulation	REG∟	$0 A \le I_0 \le 1 A$	-	3.5	40.0	mV
Quiescent Current	BIAS	Io = 0 A	-	1.8	4.0	mA
		lo = 0.5 A	_	18.0	(30.0)	mA
Startup Quiescent Current	BIAS(S)	V _{IN} = 2.4 V, Io = 0 A	-	11.0	30.0	mA
		V _{IN} = 3.1 V, Io = 1 A	-	_	(80.0)	mA
Quiescent Current Change	⊿Ibias	$3.5~V \leq V_{\text{IN}} \leq 12~V$	_	(3.0)	(15.0)	mA
Output Noise Voltage	Vn	10 Hz ≤ f ≤ 100 kHz	-	62.0	-	μVr.m.s.
Ripple Rejection	R•R	f = 120 Hz, 3.5 V \leq VIN \leq 4.5 V, Io = 0.3 A	-	60	-	dB
Dropout Voltage	VDIF	Io = 0.5 A	-	0.36	0.6	V
		lo = 1 A	-	(0.7)	-	V
Short Circuit Current	lOshort	V _{IN} = 3.5 V	(0.1)	0.6	(0.8)	А
		V _{IN} = 12 V	-	(0.4)	_	А
Peak Output Current	lOpeak	V _{IN} = 3.5 V	1.0	1.3	(1.6)	А
		V _{IN} = 12 V	-	(1.1)	_	А
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	$0^{\circ}C \leq T_{\rm J} \leq 125^{\circ}C, \ lo = 5 \ mA$	-	0.2	-	mV/°C

11 PC2925B	$T_1 = 25^{\circ}C$	$V_{IN} = 3.5 V$		$= 0.1 \mu E Co$	$uT = 10 \mu F unk$	ess otherwise sp	ocified)
μ F CZ9Z9D	13 - 25 C	, VIN – 3.5 V, I	0 - 0.5 A, CIN	$1 - 0.1 \mu$ F, CO	μ	335 Uliiei wise sp	Jecilieu)

Remark Values in parentheses are product design values, and are thus provided as reference values.

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V ₀₁		3.234	3.3	3.366	V
	V ₀₂	$4.3 \text{ V} \leq V_{\text{IN}} \leq 12 \text{ V}, 0 \text{ A} \leq I_{\text{O}} \leq 1 \text{ A}$	(3.201)	_	(3.399)	V
Line Regulation	REGIN	$4.3~V \le V_{IN} \le 12~V$	_	6.0	25.0	mV
Load Regulation	REG∟	$0 A \le I_0 \le 1 A$	_	4.2	50.0	mV
Quiescent Current	IBIAS	Io = 0 A	_	1.8	4.0	mA
		lo = 0.5 A	-	18.0	(30.0)	mA
Startup Quiescent Current	IBIAS(S)	V _{IN} = 3.1 V, I _O = 0 A	_	11.0	30.0	mA
		V _{IN} = 3.7 V, Io = 1 A	_	_	(80.0)	mA
Quiescent Current Change	⊿Ibias	$4.3~V \le V_{IN} \le 12~V$	-	(3.0)	(15.0)	mA
Output Noise Voltage	Vn	10 Hz ≤ f ≤ 100 kHz	-	82.0	_	$\mu V_{r.m.s.}$
Ripple Rejection	R•R	f = 120 Hz, 4.3 V \leq VIN \leq 5.3 V, Io = 0.3 A	-	58	-	dB
Dropout Voltage	VDIF	Io = 0.5 A	-	0.36	0.6	V
		lo = 1 A	-	(0.7)	_	V
Short Circuit Current	lOshort	V _{IN} = 5.0 V	(0.1)	0.6	(0.8)	А
		V _{IN} = 12 V	_	(0.4)	_	А
Peak Output Current	lOpeak	V _{IN} = 5.0 V	1.0	1.5	(1.6)	А
		V _{IN} = 12 V	_	(1.1)	_	А
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	$0^{\circ}C \leq T_{\rm J} \leq 125^{\circ}C, \ I_{\rm O} = 5 \ mA$	_	0.4	_	mV/°C

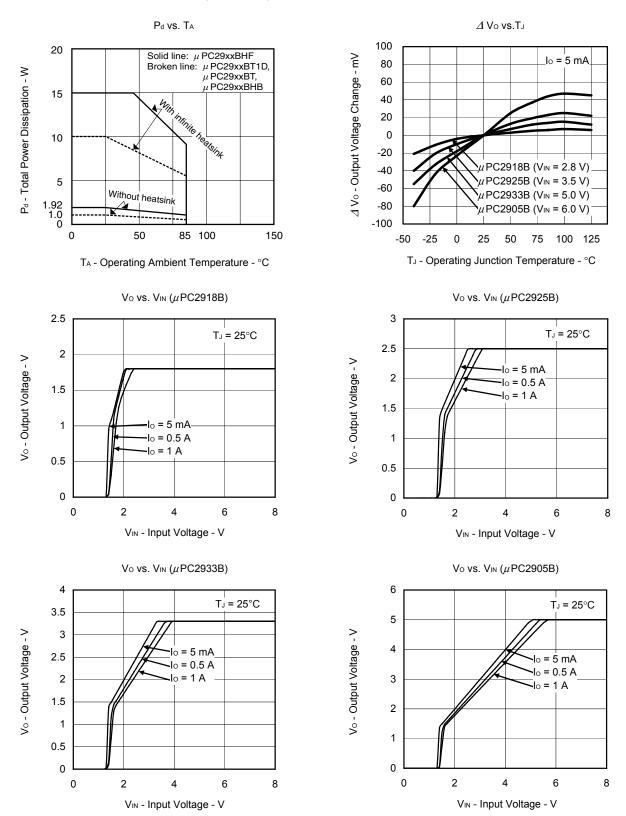
Remark Values in parentheses are product design values, and are thus provided as reference values.

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V ₀₁		4.90	5.0	5.10	V
	V ₀₂	$6.0 \text{ V} \leq V_{\text{IN}} \leq 12 \text{ V}, \text{ 0 A} \leq I_0 \leq 1 \text{ A}$	(4.85)	_	(5.15)	V
Line Regulation	REGIN	$6.0 \ V \leq V_{IN} \leq 12 \ V$	-	6.5	25.0	mV
Load Regulation	REG∟	$0 A \le I_0 \le 1 A$	-	5.0	80.0	mV
Quiescent Current	BIAS	Io = 0 A	-	1.8	4.0	mA
		lo = 0.5 A	-	18.0	(30.0)	mA
Startup Quiescent Current	BIAS(S)	V _{IN} = 4.8 V, I _O = 0 A	-	11.0	30.0	mA
		V _{IN} = 5.5 V, Io = 1 A	-	_	(80.0)	mA
Quiescent Current Change	∕IBIAS	$6.0~V \leq V_{IN} \leq 12~V$	-	(3.0)	(15.0)	mA
Output Noise Voltage	Vn	10 Hz \leq f \leq 100 kHz	-	122.0	-	μVr.m.s.
Ripple Rejection	R•R	f = 120 Hz, 6.0 V \leq VIN \leq 7 V, Io = 0.3 A	-	57	_	dB
Dropout Voltage	VDIF	lo = 0.5 A	-	0.38	0.6	V
		lo = 1 A	-	(0.7)	_	V
Short Circuit Current	lOshort	V _{IN} = 6.5 V	(0.1)	0.65	(0.8)	А
		V _{IN} = 12 V	-	(0.4)	-	А
Peak Output Current	lOpeak	V _{IN} = 6.5 V	1.0	1.5	(1.6)	А
		V _{IN} = 12 V	-	(1.1)	_	А
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	$0^{\circ}C \leq T_{J} \leq 125^{\circ}C, \ Io = 5 \ mA$	_	0.6	_	mV/°C

// PC2905B ($T_1 = 25^{\circ}C_2$	$V_{IN} = 6.0 V_{.}I_{.}$	0 = 0.5 A. CIN = 0.1	//F. COUT = 10	μ F, unless otherwise	specified)
μ 1 02000 U	(13 - 20 0)	, wiis — 0.0 v, i	0 - 0.0 R, 0 R - 0.1	$\mu_1, 0001 - 10$	μ 1, unicos ounci wisc	specificaj

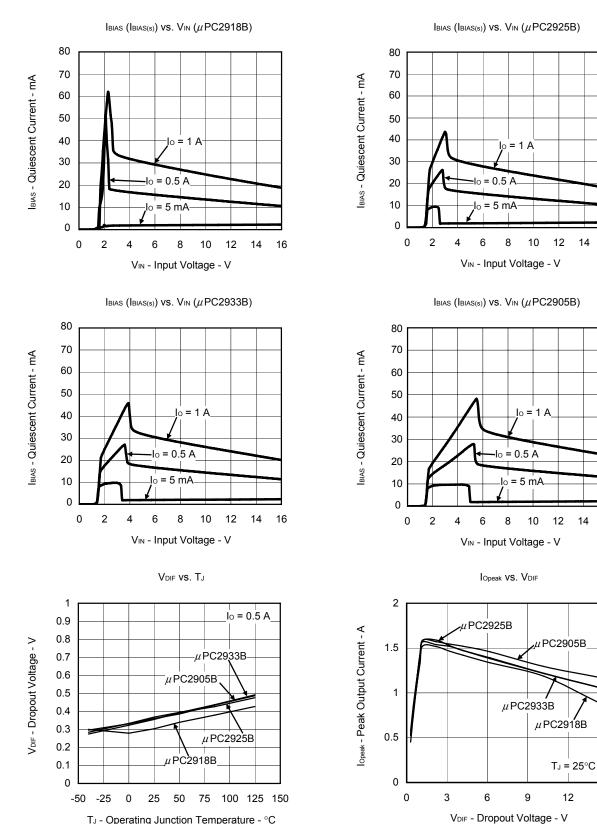
Remark Values in parentheses are product design values, and are thus provided as reference values.

TYPICAL CHARACTERISTICS (T_A = 25°C)



14 16

14 16

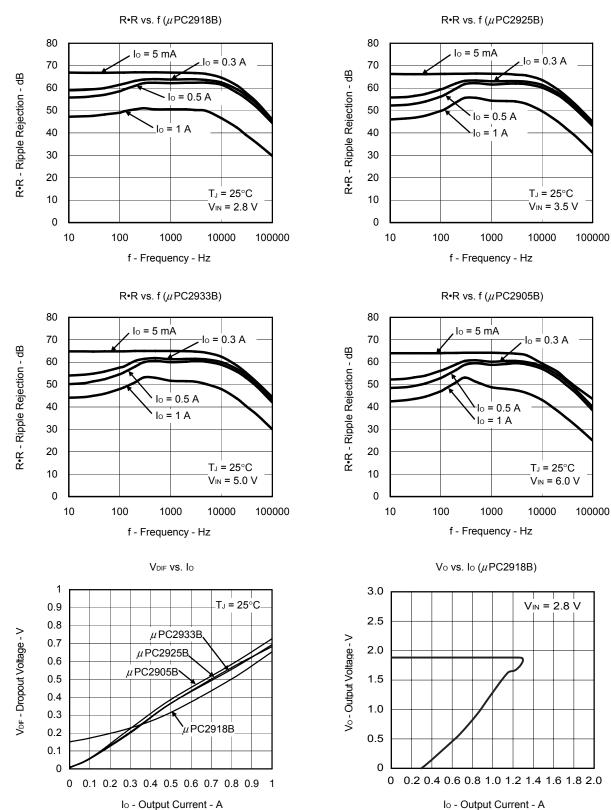


NEC

TJ - Operating Junction Temperature - °C

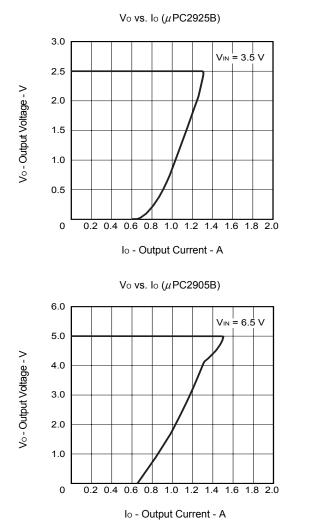
Data Sheet G17567EJ4V0DS

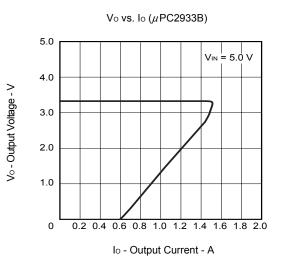
15



lo - Output Current - A

NEC





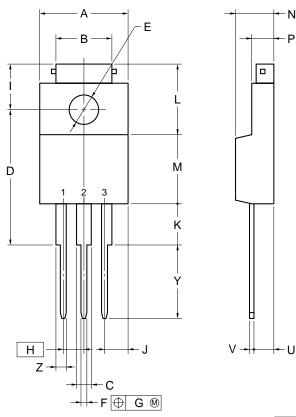
-N

Ρ

PACKAGE DRAWINGS (Unit: mm)

 μ PC2918BHF, μ PC2925BHF, μ PC2933BHF, μ PC2905BHF

3PIN PLASTIC SIP (MP-45G)



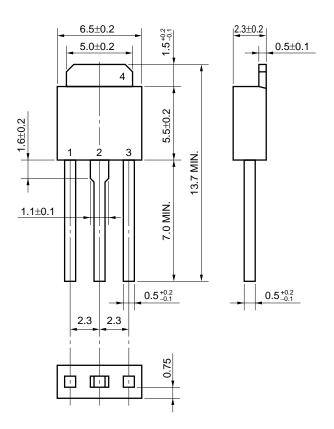
NOTE

Each lead centerline is located within 0.25 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
Α	10.0±0.2
В	7.0±0.2
С	1.50±0.2
D	17.0±0.3
Е	φ3.3±0.2
F	0.75±0.10
G	0.25
Н	2.54 (T.P.)
I	5.0±0.3
J	2.46±0.2
К	5.0±0.2
L	8.5±0.2
М	8.5±0.2
Ν	4.5±0.2
Р	2.8±0.2
U	2.4±0.5
V	0.65±0.10
Y	8.9±0.7
Z	1.30±0.2
	P3HF-254B-4

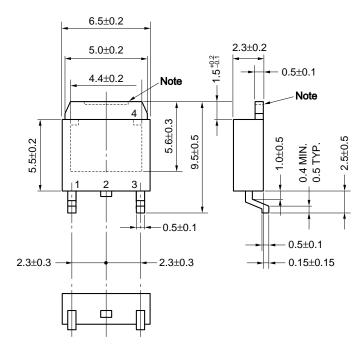
μ PC2918BHB, μ PC2925BHB, μ PC2933BHB, μ PC2905BHB

SC-64 (MP-3)



μ PC2918BT, μ PC2925BT, μ PC2933BT, μ PC2905BT

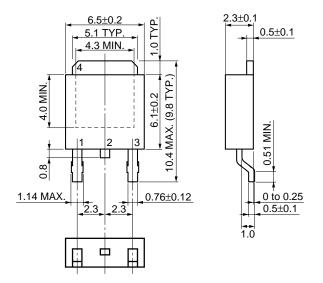
<R> SC-63 (MP-3Z) (Unit: mm)



Note The depth of notch at the top of the fin is from 0 to 0.2 mm.

μ PC2918BT1D, μ PC2925BT1D, μ PC2933BT1D, μ PC2905BT1D

TO-252 (MP-3ZK)



NEC

<R> RECOMMENDED MOUNTING CONDITIONS

The μ PC29xxB Series should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Surface Mount Device

μ PC29XXBT1D Series: 10-252 (MP-32K)			
Process	Conditions	Symbol	
Infrared Ray Reflow	Peak temperature: 260°C or below (Package surface temperature), Reflow time: 60 seconds or less (at 220°C or higher), Maximum number of reflow processes: 3 times or less.	IR60-00-3	
Vapor Phase Soldering	Peak temperature: 215°C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200°C or higher), Maximum number of reflow processes: 3 times or less.	VP15-00-3	
Partial Heating Method	Pin temperature: 350°C or below, Heat time: 3 seconds or less (Per each side of the device).	P350	

μ PC29xxBT Series: SC-63 (MP-3Z) μ PC29xxBT1D Series: TO-252 (MP-3ZK)

μ PC29xxBT-AZ Series ^{Note1}, μ PC29xxBT-AY Series ^{Note2}: SC-63 (MP-3Z)

 μ PC29xxBT1D-AT Series ^{Note3}: TO-252 (MP-3ZK)

Process	Conditions	Symbol
Infrared Ray Reflow	Peak temperature: 260°C or below (package surface temperature),	IR60-00-3
	Reflow time: 60 seconds or less (at 220°C or higher),	
	Maximum number of reflows processes: 3 times or less.	
Partial Heating Method	Pin temperature: 350°C or below,	P350
	Heat time: 3 seconds or less (per each side of the device).	

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Pb-free (This product does not contain Pb in the external electrode, Sn100% plating.)

3. Pb-free (This product does not contain Pb in the external electrode and other parts.)

Caution Apply only one kind of soldering condition to a device, except for "partial heating method", or the device will be damaged by heat stress.

Remark Flux: Rosin-based flux with low chlorine content (chlorine 0.2 Wt% or below) is recommended.

Type of Through-hole Device

μ PC29xxBHF Series, μ PC29xxBHF-AZ Series ^{Note1}: Isolated TO-220 (MP-45G)

μPC29xxBHB Series, μPC29xxBHB-AZ Series^{Note1}, μPC29xxBHB-AY Series^{Note2}: SC-64 (MP-3)

Process	Conditions	Symbol
Wave Soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less	WS60-00-1
(only to leads)		
Partial Heating Method	Pin temperature: 350°C or below, Heat time: 3 seconds or less (per each pin).	P350

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Pb-free (This product does not contain Pb in the external electrode, Sn100% plating.)

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

REFERENCE DOCUMENTS

	USER'S MANUAL USAGE OF THREE TERMINAL REGULATORS	Document No.G12702E
<r></r>	REVIEW OF QUALITY AND RELIABILITY HANDBOOK	Document No.C12769E
	INFORMATION VOLTAGE REGULATOR OF SMD	Document No.G11872E
	SEMICONDUCTOR DEVICE MOUNT MANUAL	http://www.necel.com/pkg/en/mount/index.html

- The information in this document is current as of August, 2007. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC Electronics data sheets or data books, etc., for the most up-to-date specifications of NEC Electronics products. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.
- No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Electronics. NEC Electronics assumes no responsibility for any errors that may appear in this document.
- NEC Electronics does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from the use of NEC Electronics products listed in this document or any other liability arising from the use of such products. No license, express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Electronics or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative purposes in semiconductor product operation and application examples. The incorporation of these circuits, software and information in the design of a customer's equipment shall be done under the full responsibility of the customer. NEC Electronics assumes no responsibility for any losses incurred by customers or third parties arising from the use of these circuits, software and information.
- While NEC Electronics endeavors to enhance the quality, reliability and safety of NEC Electronics products, customers agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize risks of damage to property or injury (including death) to persons arising from defects in NEC Electronics products, customers must incorporate sufficient safety measures in their design, such as redundancy, fire-containment and anti-failure features.
- NEC Electronics products are classified into the following three quality grades: "Standard", "Special" and "Specific".

The "Specific" quality grade applies only to NEC Electronics products developed based on a customerdesignated "quality assurance program" for a specific application. The recommended applications of an NEC Electronics product depend on its quality grade, as indicated below. Customers must check the quality grade of each NEC Electronics product before using it in a particular application.

- "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots.
- "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
- "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC Electronics products is "Standard" unless otherwise expressly specified in NEC Electronics data sheets or data books, etc. If customers wish to use NEC Electronics products in applications not intended by NEC Electronics, they must contact an NEC Electronics sales representative in advance to determine NEC Electronics' willingness to support a given application.

(Note)

- (1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC Electronics products" means any product developed or manufactured by or for NEC Electronics (as defined above).